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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PATENT

Applicant:

Marsden et al.

Docket No.:

97112.3036

Serial No.:

10/650,167

Group Art Unit:

TBA

Filed:

August 27, 2003

Examiner:

TBA

Title:

METHOD FOR IMPROVING METALS RECOVERY USING HIGH

TEMPERATURE PRESSURE LEACHING

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner For Patents Washington, D.C. 20231

Assistant Commissioner:

This Information Disclosure Statement is being filed in accordance with the duty of disclosure under 37 C.F.R. § 1.56 and pursuant to 37 C.F.R. §§ 1.97-1.98. The submission of the listed documents is not intended as an admission that any such document constitutes prior art against the claims of the present application. Applicant reserves the right to dispute any of the listed documents as prior art during examination. Further, Applicant does not waive any right to take any action that would be appropriate to antedate or otherwise remove any listed document as a competent reference against the claims of the present application. Furthermore, the submission of this Information Disclosure Statement is not to be construed as a representation that a search has been made or that no other material information may exist.

Pursuant to 37 C.F.R. § 1.98(d), this Information Disclosure Statement is being filed without copies of foreign patents and other cited documents as all those cited in this Information Disclosure Statement have been provided previously to the United States Patent & Trademark

Serial No.: 10/650,167 Attorney Docket No.: 97112.3036

Office filed as part of Information Disclosure Statements filed in connection with Application Serial Nos. 09/912,967 and 10/238,088, which applications are relied on for an earlier effective filing date under 35 U.S.C. § 120.

This Information Disclosure Statement is being filed under 37 C.F.R. §1.97 (b)(3), before the mailing date of a first Office Action on the merits, therefore no fee or statement is required.

If the Applicants have overlooked any fees, the Assistant Commissioner is hereby authorized to charge Deposit Account No. 19-2814 for any deficiency in the fees required for the filing of this Information Disclosure Statement. A duplicate copy of this Information Disclosure Statement is enclosed for this purpose. This statement does not authorize the payment of the issue fee.

2

Respectfully submitted,

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Dated: 30 October 2003

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use several sheets if necessary)

ATTY. DOCKET NO. 97112.3036 SERIAL NO. 10/650,167

APPLICANTS
John O. Marsden et al

FILING DATE August 27, 2003 GROUP ART UNIT TBA

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*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.